Ceramic

Balance Filter

4650 to 5150 MHz 50Ω

Features

- Small size (0.126"x0.098"x0.039")
- Temperature stable
- · Hermetically sealed
- LTCC construction

Applications

- 5G
- Cellular

BBFCV-492+



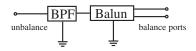
Generic photo used for illustration purposes only

CASE STYLE: JV1210C-4

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



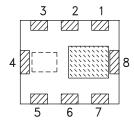
Simplified Schematic



Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Тур.	Max.	Unit
Impedance Ratio			2:1		
Insertion Loss	4650 - 5150	_	_	3.5	dB
	50-1098	28	_	_	dB
Attances	1098-4000	20	_	_	
Attenuation	6696-8049	22	_	_	
	9645-12750	10	_	_	
Amplitude Unbalance	4650-5150	_	_	1.3	dB
Phase Unbalance	4650-5150	_	_	12	degree
Input VSWR	4650-5150	_	1.67	_	

Top View



Pad Connections

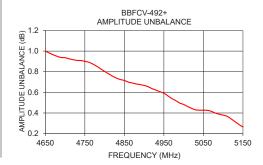
Unbalanced Port	7
Balanced Port	3, 5
GND	2, 4, 8
GND or DC Feed	6
NC	1

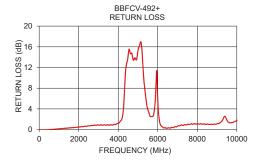
Maximum Ratings

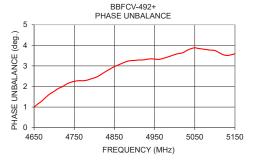
Operating Temperature	-55°C to +105°C
Storage Temperature ¹	-55°C to +105°C
RF Power Input ²	1W @25°C

 Refer to product storage temperature after installation Suggestion for T&R unused product storage condition: +5 \sim +35 $^{\circ}\text{C},$ Humidity 45~75%RH, 12 month Max 2. Derate linearly to 0.5W at 85°C





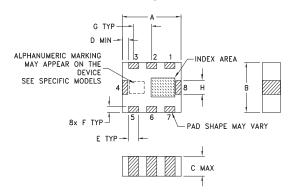


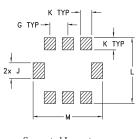


Typical	Performance	Data
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	71				
Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (Deg,)	
10	71.41	0.06	1.38	100.60	
50	81.78	0.04	2.23	151.82	
100	83.48	0.04	8.13	134.82	
500	59.00	0.08	9.62	168.96	
1000	49.41	0.26	10.86	120.62	
2000	34.69	0.62	1.97	57.65	
3000	27.42	1.00	3.11	6.88	
3500	30.50	1.00	1.03	40.22	
4000	32.88	1.31	3.27	90.58	
4650	2.52	14.66	1.00	1.33	
5150	2.17	16.82	0.26	3.55	
6000	10.14	5.42	0.91	0.65	
7000	30.56	0.79	4.17	74.13	
8000	31.83	1.25	1.36	63.10	
9000	31.36	1.24	4.95	80.75	
10000	17.71	1.88	3.06	167.42	

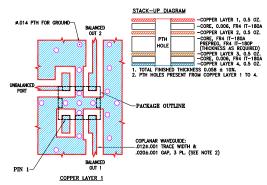
Outline Drawing





Suggested Layout, Tolerance to be within .002

Demo Board MCL P/N: TB-1053+ Suggested PCB Layout (PL-632)



- I. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.

 2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR FR4 IT-180A WITH DIELECTRIC HICKNESS, 006 ±0.007; COPPER: 1/2 0Z. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.

 3. LAYERS 2,3.4 OF THE PCB ARE CONTINUOUS RROUND PLANE.
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Outline Dimensions (inch)

G	F	E	D	С	В	Α
.039	.012	.022	.004	.039	.098	.126
1.0	0.3	0.56	0.1	1.0	2.5	3.2
wt		M	L	K	J	Н
grams		0.15	.130	.024	.031	.028
		0.10	. 100	.02 1	.001	.020

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



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